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HEET

U.S. DEPARTMENT OF COMMERCE
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101994331

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Toshihiro UEHARA
Yoshihiro MINAGI
Kenichi INOUE

Additional name(s) of conveying party(ies) attached? Yes No



2-21-02

2. Name and address of receiving party(ies):
HITACHI METALS, LTD.
2-1, Shibaura-1-chome, Minato-ku, Tokyo, Japan

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other

Execution Date: January 10, 2002

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is:
A. Patent Application No.(s)
10/000,079

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
SUGHRUE MION, PLLC
2100 Pennsylvania Avenue, N.W.
Suite 800
Washington, D.C. 20037-3213

6. Total number of applications and patents involved:
1
7. Total fee (37 CFR 3.41): \$40.00
 Enclosed. Please charge any underpayment in connection with this Assignment to Deposit Account No. 19-4880.
 Authorized to be charged to deposit account
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19-4880
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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter D. Olexy Reg. No. 24,513 February 21, 2002 Date

Total number of pages including cover sheet, attachments, and documents: 2
Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks
Box Assignment
Washington, D.C. 20231

02/27/2002 LMUELLER 00000031 10000079
01 FC:581 40.00 DP

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI METALS, LTD., a corporation organized under the laws of Japan, located at 2-1, Shibaura-1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI METALS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to "A FERRITIC Fe-Cr-Ni-Al ALLOY HAVING EXCELLENT OXIDATION RESISTANCE AND HIGH STRENGTH AND A PLATE MADE OF THE ALLOY"

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

U.S. Serial No. 10/000,079 filed on December 4, 2001

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI METALS, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI METALS, LTD.

Signed on the date(s) indicated aside signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	WITNESSES (立会人サイン)
1)	<u>Toshihiro Uehara</u> Toshihiro UEHARA	<u>January 10, 2002</u>	<u>Hidetsu Yamada</u>
2)	<u>Yoshihiro Minagi</u> Yoshihiro MINAGI	<u>January 10, 2002</u>	<u>Hidetsu Yamada</u>
3)	<u>Kenichi Inoue</u> Kenichi INOUE	<u>January 10, 2002</u>	<u>Hidetsu Yamada</u>
4)	_____	_____	_____
5)	_____	_____	_____
6)	_____	_____	_____
7)	_____	_____	_____
8)	_____	_____	_____
9)	_____	_____	_____